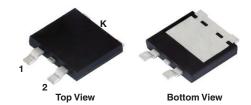
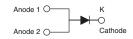


Ultrafast Rectifier, 16 A FRED Pt®

eSMP[®] Series SMPD (TO-263AC)





LINKS TO ADDITIONAL RESOURCES



| PRIMARY CHARACTERISTICS | | | | |
|----------------------------------|-----------------|--|--|--|
| I _{F(AV)} | 16 A | | | |
| V _R | 600 V | | | |
| V _F at I _F | 0.91 V | | | |
| t _{rr} | 55 ns | | | |
| T _J max. | 175 °C | | | |
| Package | SMPD (TO-263AC) | | | |
| Circuit configuration | Single | | | |

FEATURES

 Ultrafast recovery time, reduced Q_{rr}, and soft recovery



• 175 °C maximum operating junction temperature

For PFC CRM, snubber operation

COMPLIANT HALOGEN FREE

Low forward voltage drop

- Low forward voltage are
- Low leakage current
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Meets JESD 201 class 2 whisker test
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

DESCRIPTION / APPLICATIONS

State of the art ultrafast recovery rectifiers designed with optimized performance of forward voltage drop and ultrafast recovery time, and soft recovery.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness, and reliability characteristics.

These devices are intended for use in PFC, boost, lighting, in the AC/DC section of SMPS, freewheeling and clamp diodes.

Their extremely optimized stored charge and low recovery current minimize the switching losses and reduce power dissipation in the switching element and snubbers.

MECHANICAL DATA

Case: SMPD (TO-263AC)

Molding compound meets UL 94 V-0 flammability rating

Halogen-free, RoHS-compliant

Terminals: matte tin plated leads, solderable per

J-STD-002

| ABSOLUTE MAXIMUM RATINGS | 3 | | | |
|-----------------------------------|--------------------|---|--------|-------|
| PARAMETER | SYMBOL | TEST CONDITIONS | VALUES | UNITS |
| Peak repetitive reverse voltage | V_{RRM} | | 600 | V |
| Average rectified forward current | I _{F(AV)} | T _{solder pad} = 141 °C | 16 | ۸ |
| Non-repetitive peak surge current | I _{FSM} | T _J = 25 °C, 6 ms square pulse | 160 | ^ |

| ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified) | | | | | | |
|--|--|---|------|------|------|-------|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| Breakdown voltage, blocking voltage | V_{BR}, V_{R} | I _R = 100 μA | 600 | - | - | |
| Forward voltage V _F | V | I _F = 16 A | - | 1.04 | 1.25 | V |
| | I _F = 16 A, T _J = 150 °C | - | 0.91 | 1.1 | | |
| Reverse leakage current I _R | | $V_R = V_R$ rated | - | - | 15 | |
| | ^I R | $T_J = 150 ^{\circ}\text{C}, V_R = V_R \text{rated}$ | - | 70 | 300 | μA |
| Junction capacitance | C _T | V _R = 600 V | - | 16 | - | pF |



| DYNAMIC RECOVERY CHARACTERISTICS (T _J = 25 °C unless otherwise specified) | | | | | | | |
|---|-------------------------|--|---|------|------|------|-------|
| PARAMETER | SYMBOL | TEST CONDITIONS | | MIN. | TYP. | MAX. | UNITS |
| | | $I_F = 1 A, dI_F/dt = 50 A$ | √μs, V _R = 30 V | - | 55 | - | |
| Reverse recovery time | + | I _F = 0.5 A, I _R = 1 A, I _{rr} = 0.25 A | | - | - | 55 | |
| heverse recovery time | t _{rr} | T _J = 25 °C | I _F = 16 A, dI _F /dt = 500 A/μs, | - | 100 | - | ns |
| | | T _J = 125 °C | | - | 150 | - | |
| Dook receivent ourrent | | T _J = 25 °C | | - | 20 | - | ۸ |
| Peak recovery current I _{RRM} | T _J = 125 °C | $V_{R} = 400 \text{ V}$ | - | 27 | - | A | |
| Poverse receivery charge | T _J = 25 °C | | - | 1 | - | μC | |
| Reverse recovery charge | Q _{rr} | T _J = 125 °C | | - | 2 | - | μΟ |

| THERMAL - MECHANICAL SPECIFICATIONS | | | | | | |
|--|-----------------------------------|----------------------------|------|------|------|-------|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| Maximum junction and storage temperature range | T _J , T _{Stg} | | -55 | - | +175 | °C |
| Thermal resistance, junction to mount | R _{thJM} | | - | 1.2 | 1.7 | °C/W |
| Approximate weight | | | | 0.55 | | g |
| Marking device | | Case style SMPD (TO-263AC) | | 16EI | DU06 | |

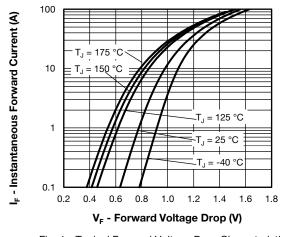


Fig. 1 - Typical Forward Voltage Drop Characteristics

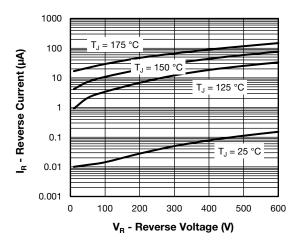


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

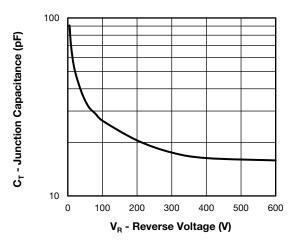


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

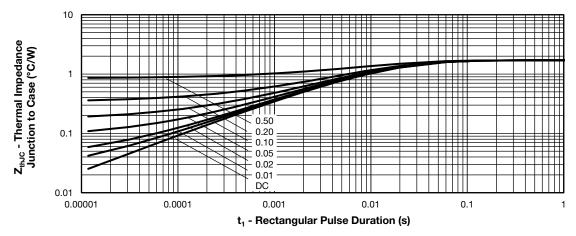


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics

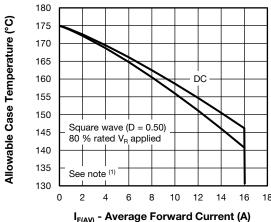
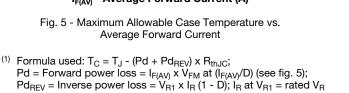


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current



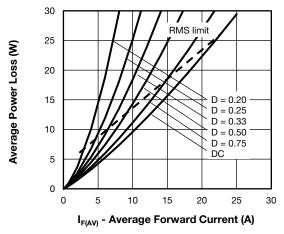
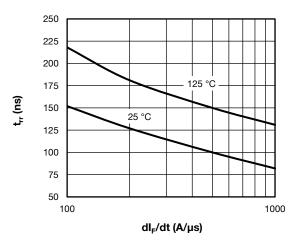


Fig. 6 - Forward Power Loss Characteristics

www.vishay.com

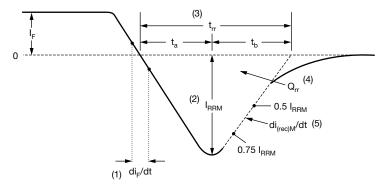
Vishay Semiconductors



2500 2000 2000 1500 500 1000 1000 1000 1000 1000

Fig. 7 - Typical Reverse Recovery Time vs. dl_F/dt

Fig. 8 - Typical Stored Charge vs. dl_F/dt



- (1) di_F/dt rate of change of current through zero crossing
- (2) I_{RRM} peak reverse recovery current
- (3) $\rm t_{rr}$ reverse recovery time measured from zero crossing point of negative going $\rm l_{r}$ to point where a line passing through 0.75 $\rm l_{RRM}$ and 0.50 $\rm l_{RRM}$ extrapolated to zero current.
- (4) \mathbf{Q}_{rr} area under curve defined by \mathbf{t}_{rr} and \mathbf{I}_{RRM}

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

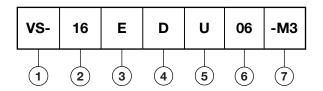
(5) di_{(rec)M}/dt - peak rate of change of current during t_b portion of t_{rr}

Fig. 9 - Reverse Recovery Waveform and Definitions



ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

Current rating (16 A)

3 - Circuit configuration:

E = single die

4 - D = SMPD package

Process type,

U = ultrafast recovery

6 - Voltage code (06 = 600 V)

7 - -M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free

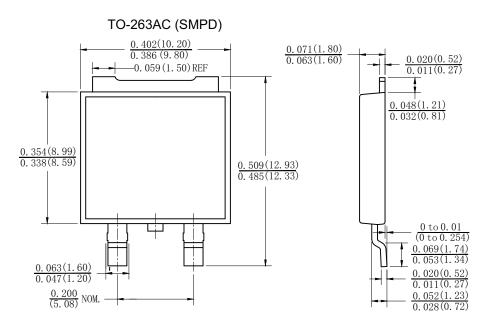
| ORDERING INFORMATION (Example) | | | | | |
|--------------------------------|-------------------|------------------------|------------------------------------|--|--|
| PREFERRED P/N | QUANTITY PER REEL | MINIMUM ORDER QUANTITY | PACKAGING DESCRIPTION | | |
| VS-16EDU06-M3/I | 2000 | 2000 | 13" diameter plastic tape and reel | | |

| LINKS TO RELATED DOCUMENTS | | | | |
|----------------------------|--------------------------|--|--|--|
| Dimensions | www.vishay.com/doc?95604 | | | |
| Part marking information | www.vishay.com/doc?95566 | | | |
| Packaging information | www.vishay.com/doc?88869 | | | |
| SPICE model | www.vishay.com/doc?96771 | | | |

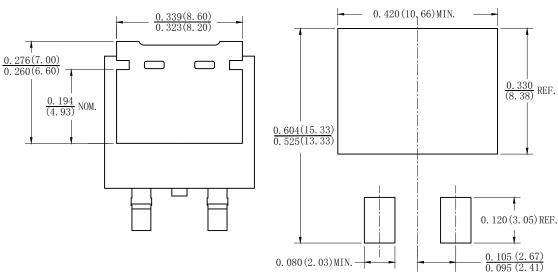


TO-263AC (SMPD)

DIMENSIONS in inches (millimeters)



Mounting Pad Layout





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Vishay

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